

# Secondary Side Average Current Mode Controller

## FEATURES

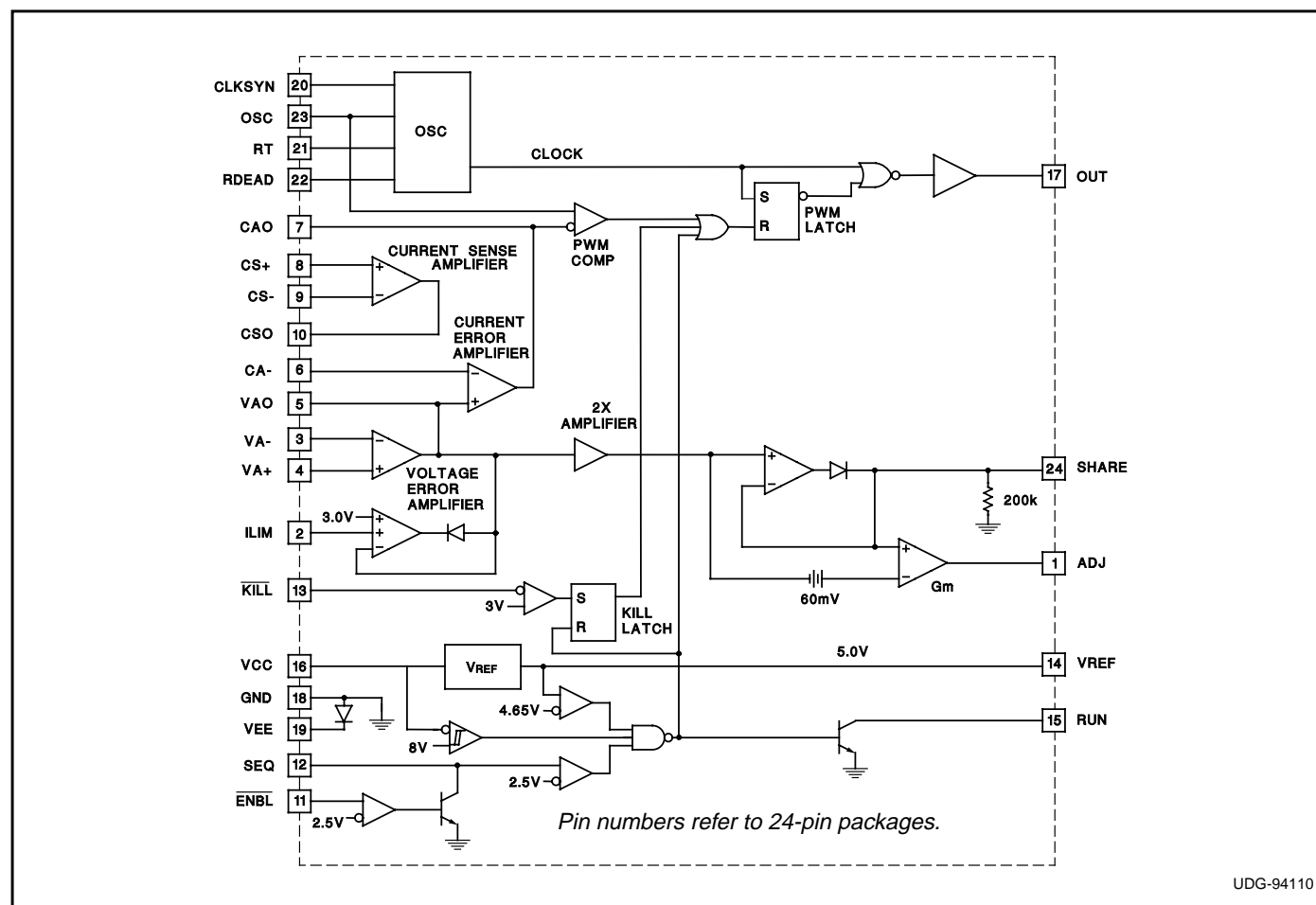
- Practical Secondary Side Control of Isolated Power Supplies
- 1MHz Operation
- Differential AC Switching Current Sensing
- Accurate Programmable Maximum Duty Cycle
- Multiple Chips Can be Synchronized to Fastest Oscillator
- Wide Gain Bandwidth Product (70MHz,  $A_{cl} > 10$ ) Current Error and Current Sense Amplifiers
- Up to Ten Devices Can Easily Share a Common Load

## DESCRIPTION

The UC3849 family of average current mode controllers accurately accomplishes secondary side average current mode control. The secondary side output voltage is regulated by sensing the output voltage and differentially sensing the AC switching current. The sensed output voltage drives a voltage error amplifier. The AC switching current, monitored by a current sense resistor, drives a high bandwidth, low offset current sense amplifier. The outputs of the voltage error amplifier and current sense amplifier differentially drive a high bandwidth, integrating current error amplifier. The sawtooth waveform at the current error amplifier output is the amplified and inverted inductor current sensed through the resistor. This inductor current down-slope compared to the PWM ramp achieves slope compensation, which gives an accurate and inherent fast transient response to changes in load.

The UC3849 features load share, oscillator synchronization, undervoltage lockout, and programmable output control. Multiple chip operation can be achieved by connecting up to ten UC3849 chips in parallel. The SHARE bus and CLKSYN bus provide load sharing and synchronization to the fastest oscillator respectively. The UC3849 is an ideal controller to achieve high power, secondary side average current mode control.

## BLOCK DIAGRAM



UDG-94110

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage (VCC)	20V
Output Current Source or Sink	0.3A
Analog Input Voltages	−0.3V to 7V
ILIM, KILL, SEQ, ENBL, RUN	−0.3V to 7V
CLKSYN Current Source	12mA
RUN Current Sink	15mA
SEQ Current Sink	20mA
RDEAD Current Sink	20mA
Share Bus Voltage (voltage with respect to GND)	0V to 6.2V
ADJ Voltage (voltage with respect to GND)	0.9V to 6.3V
VEE (voltage with respect to GND)	−1.5V
Storage Temperature	−65°C to +150°C

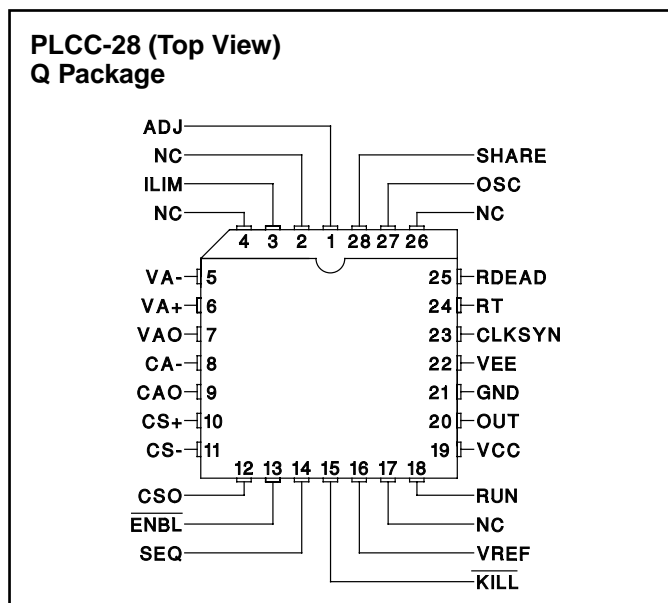
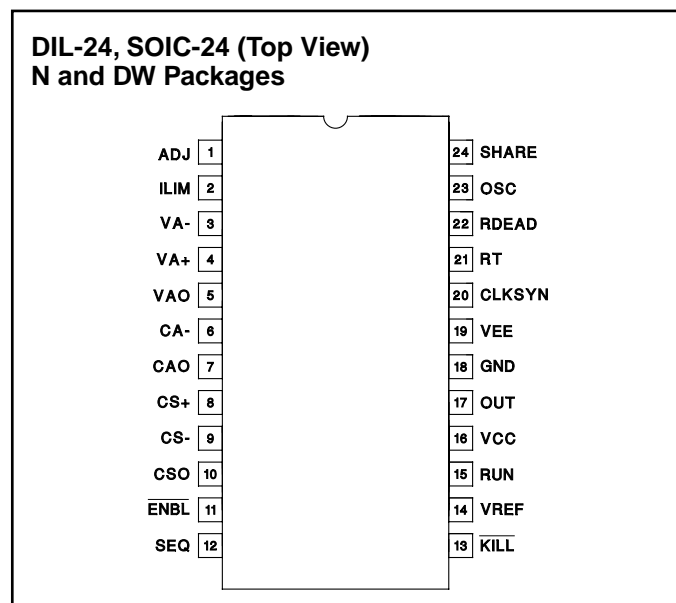
Junction Temperature	−65°C to +150°C
Lead Temperature (Soldering, 10 sec.)	+300°C

All voltages with respect to VEE except where noted; all currents are positive into, negative out of the specified terminal. Consult Packaging Section of Databook for thermal limitations and considerations of packages.

## RECOMMENDED OPERATING CONDITIONS

Input Voltage	8V to 20V
Sink/Source Output Current	250mA
Timing Resistor (RT)	1k to 200k
Timing Capacitor (CT)	75pF to 2nF

## CONNECTION DIAGRAMS



**ELECTRICAL CHARACTERISTICS:** Unless otherwise stated these specifications apply for  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$  for UC2849; and  $0^\circ\text{C}$  to  $+70^\circ\text{C}$  for UC3849; VCC = 12V, VEE = GND, Output no load, CT = 345pF, RT = 4530 $\Omega$ , RDEAD = 511 $\Omega$ , RCLKSYN = 1k,  $T_A = T_J$ .

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
<b>Current Sense Amplifier</b>					
Ib			0.5	3	$\mu\text{A}$
Vio	$T_A = +25^\circ\text{C}$			3	mV
	Over Temperature			5	mV
Avo		60	90		dB
GBW (Note 2)	Acl = 1, $R_{IN} = 1\text{k}$ , CC = 15pF, f = 200kHz (Note 1)	4.5	7		MHz
Vol	$I_O = 1\text{mA}$ , Voltage above VEE		0.5		V
Voh	$I_O = 0\text{mA}$		3.8		V
	$I_O = -1\text{mA}$		3.5		V
CMRR	$-0.2 < V_{cm} < 6.5\text{V}$		80		dB
PSRR	$10\text{V} < \text{VCC} < 20\text{V}$		80		dB
<b>Current Error Amplifier</b>					
Ib			0.5	3	$\mu\text{A}$
Vio			3	20	mV

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PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
<b>Current Error Amplifier (cont.)</b>					
Avo		60	90		dB
GBW (Note 2)	$A_{cl} = 1$ , $R_{IN} = 1\text{k}$ , $CC = 15\text{pF}$ , $f = 200\text{kHz}$ (Note 1)	4.5	7		MHz
Vol	$I_O = 1\text{mA}$ , Voltage above VEE		0.5		V
Voh	$I_O = 0\text{mA}$		3.8		V
	$I_O = -1\text{mA}$		3.5		V
CMRR	$-0.2 < V_{cm} < 6.5\text{V}$		80		dB
PSRR	$10\text{V} < V_{CC} < 20\text{V}$		80		dB
<b>Voltage Error Amplifier</b>					
Ib			0.5	3	$\mu\text{A}$
Vio			2	5	mV
Avo		60	90		dB
GBW (Note 2)	$f = 200\text{kHz}$	4.5	7		MHz
Vol	$I_O = 175\mu\text{A}$ , Volts above VEE		0.3	0.6	V
Voh	$ILIM > 3\text{V}$	2.85	3	3.15	V
Voh - ILIM	Tested $ILIM = 0.5\text{V}$ , $1.0\text{V}$ , $2.0\text{V}$	-100		100	mV
CMRR	$-0.2 < V_{cm} < 6.5\text{V}$		80		dB
PSRR	$10\text{V} < V_{CC} < 20\text{V}$		80		dB
<b>2X Amplifier and Share Amplifier</b>					
V offset (b; $y = mx + b$ )				20	mV
GAIN (m; $y = mx + b$ )	Slope with $AV_{OUT} = 1\text{V}$ and $2\text{V}$	1.98		2.02	V
GBW (Note 2)			100		kHz
RSHARE	$V_{CC} = 0$ , $V_{SHARE}/I_{SHARE}$		200		k
Total Offset	Negative supply is VEE, GND Open, $VAO = \text{GND}$	-75	0	75	mV
Vol	$VAO = \text{Voltage Amplifier Vol}$ , Volts above VEE	0.2	0.45	0.6	V
Voh	$I_O = 0\text{mA}$ , $ILIM = 3\text{V}$ , $VAO = \text{Voltage Amp Voh}$	5.7	6	6.3	V
	$I_O = -1\text{mA}$ , $ILIM = 3\text{V}$ , $VAO = \text{Voltage Amp Voh}$	5.7	6	6.3	V
<b>Adjust Amplifier</b>					
Vio		40	60	80	mV
gm	$I_{OUT} = -10\mu\text{A}$ to $10\mu\text{A}$ , $V_{OUT} = 3.5\text{V}$ , $C_{ADJ} = 1\mu\text{F}$		-1		mS
Vol	$I_{OUT} = 0$	0.9	1	1.1	V
	$I_{OUT} = 50\mu\text{A}$	0.85	1	1.15	V
Voh	$I_{OUT} = 0$ , $V_{SHARE} = 6.5\text{V}$	5.7	6	6.3	V
	$I_{OUT} = -50\mu\text{A}$ , $V_{SHARE} = 6.5\text{V}$	5.7	6	6.3	V
<b>Oscillator</b>					
Frequency		450	500	550	kHz
Max Duty Cycle		80	85	90	%
OSC Ramp Amplitude		2	2.5	2.8	V
<b>Clock Driver/SYNC (CLKSYN)</b>					
Vol			0.02	0.2	V
Voh			3.6		V
	$R_{CLKSYN} = 200\Omega$		3.2		V
ISOURCE			25		mA
RCLKSYN	$V_{CC} = 0$ , $V_{CLKSYN}/I_{CLKSYN}$		10		k
VTH			1.5		V

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PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
<b>VREF Comparator</b>					
Turn-on threshold			4.65		V
Hysteresis			0.4		V
<b>VCC Comparator</b>					
Turn-on Threshold		7.9	8.3	8.7	V
Hysteresis			0.4		V
<b>KILL Comparator</b>					
Voltage Threshold			3		V
<b>Sequence Comparator</b>					
Voltage Threshold			2.5		V
SEQ SAT	$I_O = 10\text{mA}$		0.25		V
<b>Enable Comparator</b>					
Voltage Threshold			2.5		V
RUN SAT	$I_O = 10\text{mA}$		0.25		V
<b>Reference</b>					
VREF	$T_A = 25^{\circ}\text{C}$	4.95	5	5.05	V
VREF	$V_{CC} = 15\text{V}$	4.9		5.1	V
Line Regulation	$10 < V_{CC} < 20$		3	15	mV
Load Regulation	$0 < I_O < 10\text{mA}$		3	15	mV
Short Circuit I	$V_{REF} = 0\text{V}$	30	60	90	mA
<b>Output Stage</b>					
Rise Time	$C_L = 100\text{pF}$		10	20	ns
Fall Time	$C_L = 100\text{pF}$		10	20	ns
Voh	$V_{CC} > 11\text{V}$ , $I_O = -10\text{mA}$	8.0	8.4	8.8	V
	$I_O = -200\text{mA}$	7.8			V
Vol	$I_O = 200\text{mA}$			3.0	V
	$I_O = 10\text{mA}$			0.5	V
<b>Virtual Ground</b>					
$V_{GND-VEE}$	VEE is externally supplied, GND is floating and used as Signal GND.	0.2	0.75		V
<b>Icc</b>					
Icc (run)			21	30	mA

Note 1: If a closed loop gain greater than 1 is used, the possible GBW will increase by a factor of  $ACL + 10$ ; where  $ACL$  is the closed loop gain.

Note 2: Ensured by design not 100% tested in production.

Note 3: Unless otherwise specified all voltages are with respect to GND. Currents are positive into, negative out of the specified terminal.

## PIN DESCRIPTIONS

**ADJ:** The output of the transconductance ( $g_m = -1\text{mS}$ ) amplifier adjusts the control voltage to maintain equal current sharing. The chip sensing the highest output current will have its output clamped to 1V. A resistor divider between VREF and ADJ drives the control voltage ( $V_{A+}$ ) for the voltage amplifier. Each slave unit's ADJ voltage increases (to a maximum of 6V) its control voltage ( $V_{A+}$ ) until its load current is equal to the master. The 60mV in-

put offset on the  $g_m$  amplifier guarantees that the unit sensing the highest load current is chosen as the master. The 60mV offset ensures by design to be greater than the inherent offset of the  $g_m$  amplifier and the buffer amplifier. While the 60mV offset represents an error in current sharing, the gain of the current and 2X amplifiers reduces it to only 30mV. This pin needs a  $1\mu\text{F}$  capacitor to compensate the amplifier.

**PIN DESCRIPTIONS (cont.)**

**CA–:** The inverting input to the current error amplifier. This amplifier needs a capacitor between CA– and CAO to set its dominant pole.

**CAO:** The output of the current error amplifier which is internally clamped to 4V. It is internally connected to the inverting input of the PWM comparator.

**CS–, CS+:** The inverting and non-inverting inputs to the current sense amplifier. This amplifier is not internally compensated so the user must compensate externally to attain the highest GBW for the application.

**CLKSYN:** The clock and synchronization pin for the oscillator. This is a bidirectional pin that can be used to synchronize several chips to the fastest oscillator. Its input synchronization threshold is 1.4V. The CLKSYN voltage is 3.6V when the oscillator capacitor (CT) is being discharged, otherwise it is 0V. If the recommended synchronization circuit is not used, a 1k or lower value resistor from CLKSYN to GND may be needed to increase fall time on CLKSYN pin.

**CSO:** The output of the current sense amplifier which is internally clamped to 4V.

**ENBL:** The active low input with a 2.5V threshold enables the output to switch. SEQ and RUN are driven low when ENBL is above its 2.5V threshold.

**GND:** The signal ground used for the voltage sense amplifier, current sense amplifier, current error amplifier, voltage reference, 2X amplifier, and share amplifier. The output sink transistor is wired directly to this pin.

**KILL:** The active low input with a 3.0V threshold stops the output from switching. Once this function is activated RUN must be cycled low by driving KILL above 3.0V and either resetting the power to the chip (VCC) or resetting the ENBL signal.

**ILIM:** A voltage on this pin programs the voltage error amplifier's Voh clamp. The voltage error amplifier output represents the average output current. The Voh clamp consequently limits the output current. If ILIM is tied to VREF, it defaults to 3.0V. A voltage less than 3.0V connected to ILIM clamps the voltage error amplifier at this voltage and consequently limits the maximum output current.

**OSC:** The oscillator ramp pin which has a capacitor (CT) to ground and a resistor (RDEAD) to the RDEAD pin programs its maximum duty cycle by programming a minimum dead time. The ramp oscillates between 1.2V to 3.4V when an RDEAD resistor is used. The maximum duty cycle can be increased by connecting RDEAD to OSC which changes the oscillator ramp to vary between 0.2V and 3.5V. In order to guarantee zero duty cycle in this configuration VEE should not be connected to GND.

The charge time is approximately  $T_{CHARGE} = R_T \cdot C_T$  when the RDEAD resistor is used.

The dead time is approximately  $T_{DISCHARGE} = 2 \cdot RDEAD \cdot C_T$ .

$$(1) \text{ Frequency} \approx \frac{1}{T_{CHARGE} + T_{DISCHARGE}}$$

$$(2) \text{ Maximum Duty Cycle} \approx \frac{T_{CHARGE}}{T_{CHARGE} + T_{DISCHARGE}}$$

The  $C_T$  capacitance should be increased by approximately 40pF to account for parasitic capacitance.

**OUT:** The output of the PWM driver. It has an upper clamp of 8.5V. The peak current sink and source are 250mA. All UVLO, SEQ, ENBL, and KILL logic either enable or disable the output driver.

**RDEAD:** The pin that programs the maximum duty cycle by connecting a resistor between it and OSC. The maximum duty cycle is decreased by increasing this resistor value which increases the discharge time. The dead time, the time when the output is low, is  $2 \cdot RDEAD \cdot C_T$ . The  $C_T$  capacitance should be increased by approximately 40pF to account for parasitic capacitance.

**RT:** This pin programs the charge time of the oscillator ramp. The charge current is

$$\frac{VREF}{2 \cdot R_T}$$

The charge time is approximately  $T_{CHARGE} \approx R_T \cdot C_T$  when the RDEAD resistor is used.

The dead time is approximately  $T_{DISCHARGE} \approx 2 \cdot RDEAD \cdot C_T$ .

**RUN:** This is an open collector logic output that signifies when the chip is operational. RUN is pulled high to VREF through an external resistor when VCC is greater than 8.4V, VREF is greater than 4.65V, SEQ is greater than 2.5V, and KILL lower than 3.0V. RUN connected to the VA+ pin and to a capacitor to ground adds an RC rise time on the VA+ pin initiating a soft start.

**SEQ:** The sequence pin allows the sequencing of startup for multiple units. A resistor between VREF and SEQ and a capacitor between SEQ and GND creates a unique RC rise time for each unit which sequences the output startup.

**SHARE:** The nearly DC voltage representing the average output current. This pin is wired directly to all SHARE pins and is the load share bus.

**VA+, VA–:** The inverting and non-inverting inputs to the voltage error amplifier.

## PIN DESCRIPTIONS (cont.)

**VAO:** The output of the voltage error amplifier. Its  $V_{oh}$  is clamped with the ILIM pin.

**VCC:** The input voltage of the chip. The chip is operational between 8.4V and 20V.

**VEE:** The negative supply to the chip which powers the lower voltage rail for all amplifiers. The chip is operational if VEE is connected to GND or if GND is floating. When

voltage is applied externally to VEE, GND becomes a virtual ground because of an internal diode between VEE and GND. The GND current flows through the forward biased diode and out VEE. GND is always the signal ground from which the voltage reference and all amplifier inputs are referenced.

**VREF:** The reference voltage equal to 5.0V.

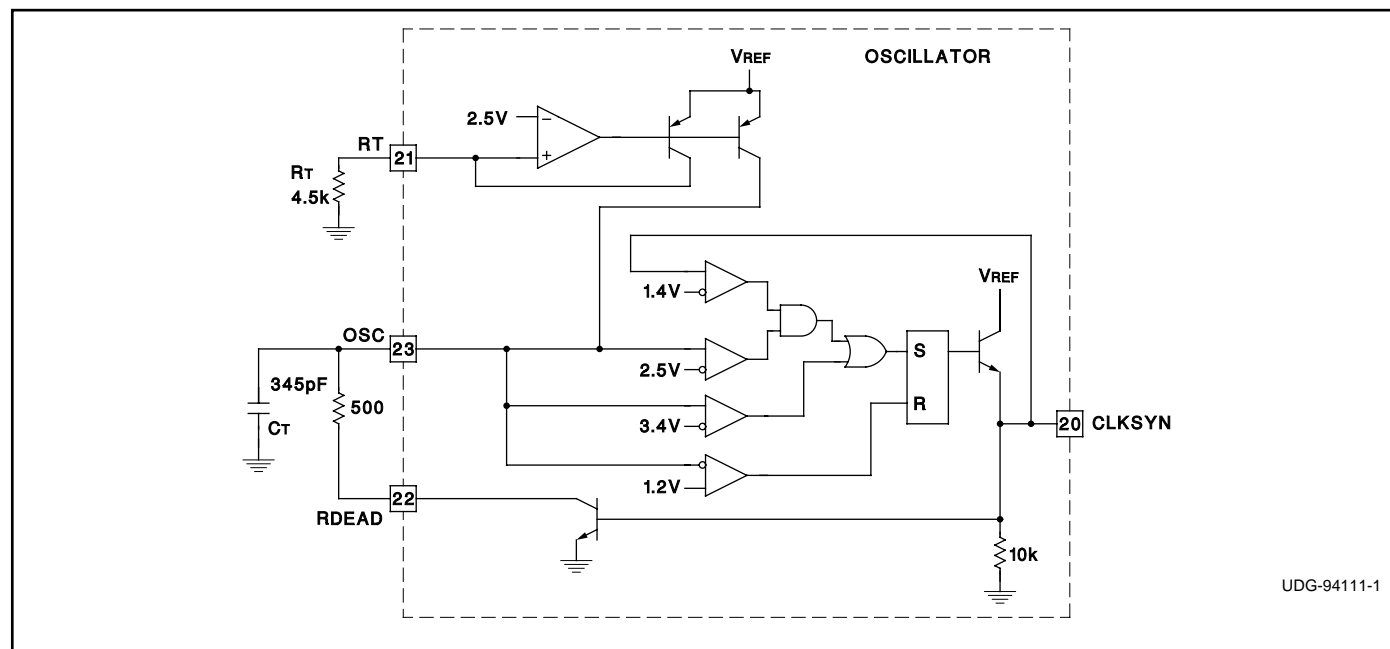


Figure 1. Oscillator Block with External Connections

## CIRCUIT BLOCK DESCRIPTION:

**PWM Oscillator:** The oscillator block diagram with external connections is shown in Figure 1. A resistor ( $R_T$ ) connected to pin RT sets the linear charge current;

$$I_{RT} \approx \frac{2.5V}{R_T}$$

The timing capacitor ( $C_T$ ) is linearly charged with the charge current forcing the OSC pin to charge to a 3.4V threshold. After exceeding this threshold, the RS flip-flop is set driving CLKSYN high and RDEAD low which discharges  $C_T$ . This discharge time with the RC time delay of  $2 \cdot C_T \cdot RDEAD$  is the minimum output low time. OSC continues to discharge until it reaches a 1.2V threshold and resets the RS flip-flop which repeats the charging sequence as shown in Figure 2. Equations to approximate frequency and maximum duty cycle are listed under the OSC pin description. Figure 3 and 4 graphs show measured variation of frequency and maximum duty cycle with varying  $R_T$ ,  $C_T$ , and  $RDEAD$  component values.

As shown in Figure 5, several oscillators are synchronized to the highest free running frequency by connect-

ing 100pF capacitors in series with each CLKSYN pin and connecting the other side of the capacitors together forming the CLKSYN bus. The CLKSYN bus is then pulled down to ground with a resistance of approximately 10k. Referring to Figure 1, the synchronization threshold is 1.4V. The oscillator blanks any synchronization pulse that occurs when OSC is below 2.5V. This allows units, once they discharge below 2.5V, to continue through the

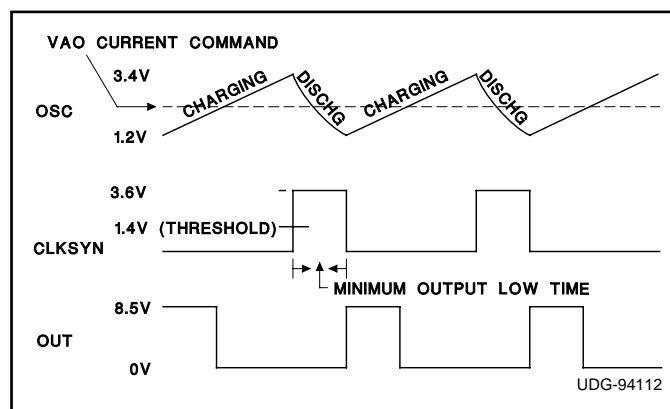


Figure 2. Oscillator and PWM Output Waveform

## CIRCUIT BLOCK DESCRIPTION (cont.)

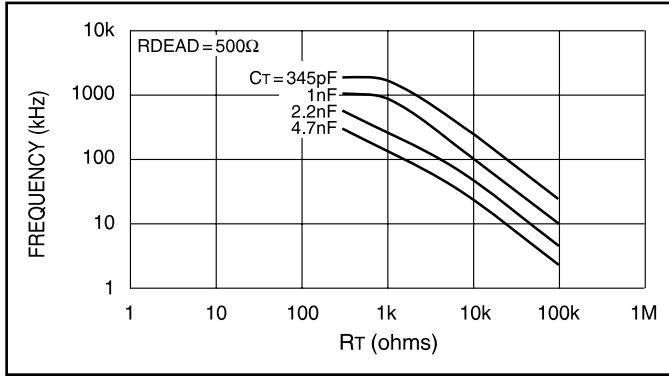


Figure 3. Output Frequency

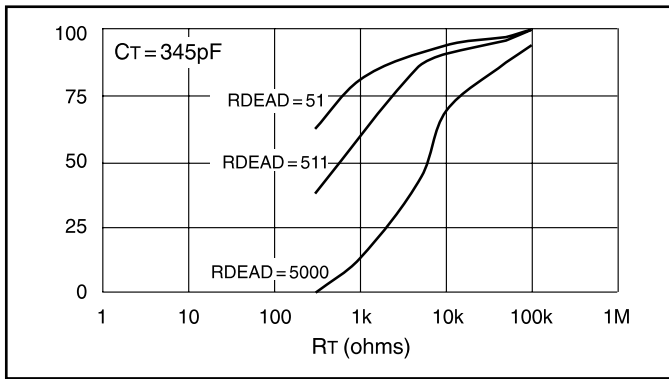


Figure 4. Maximum Duty Cycle

current discharge and subsequent charge cycles whether or not other units on the CLKSYN bus are still synchronizing. This requires the frequency of all free running oscillators to be within 40% of each other to guarantee synchronization.

**Grounds, Voltage Sensing and Current Sensing:** The voltage is sensed directly at the load. Proper load sharing requires the same sensed voltage for each power supply connected in parallel. Referring to Figure 6, the positive sense voltage (VSP) connects to the voltage error amplifier inverting terminal (VA-), the return lead for the on-chip reference is used as the negative sense (VSM). The current is sensed across the shunt resistor,  $R_S$ .

Figure 6 shows one recommended voltage and current sensing scheme when VEE is connected to GND. The signal ground is the negative sense point for the output voltage and the positive sense point for the output current. The voltage offset on the current sense amplifier is not needed if VEE is separated from GND. VEE is the negative supply for the current sense amplifier. When it is separated from GND, it extends the current sense amplifier's common mode input voltage range to include VEE which is approximately  $-0.7V$  below ground. The resistor  $R_{ADJ}$  is used for load sharing. The unit which is the master will force  $V_{ADJ}$  to  $1.0V$ . Therefore, the regulated voltage being sensed is actually:

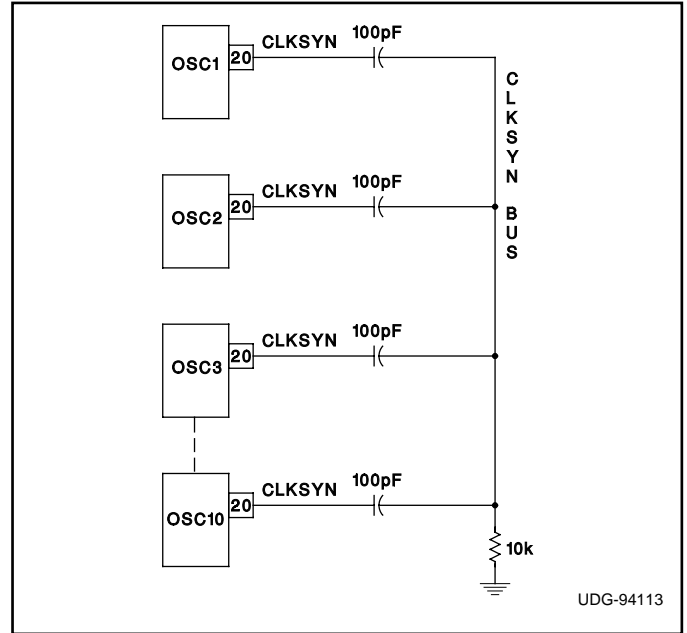


Figure 5. Oscillator Synchronization Connection Diagram

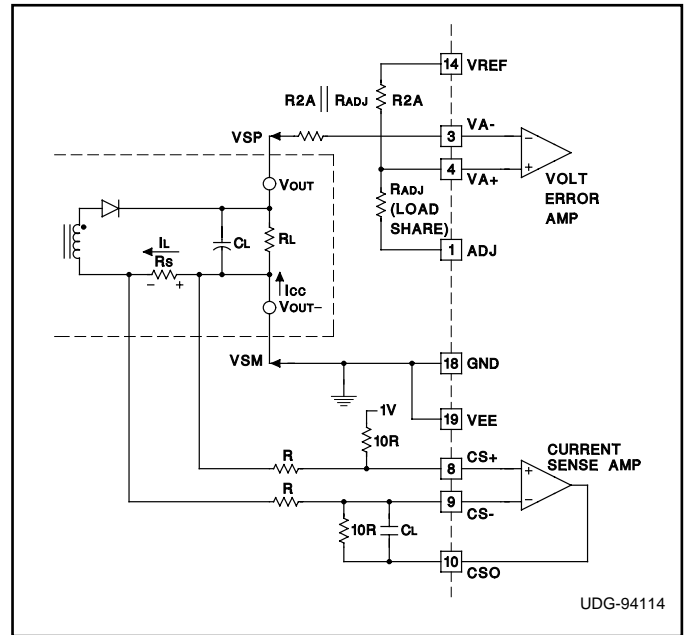


Figure 6. Voltage and Current Sense VEE Tied to GND

$$VSP - VSM = (VREF - V_{ADJ}) \cdot \left( \frac{R_{ADJ}}{R1 + R_{ADJ}} \right) + V_{ADJ}$$

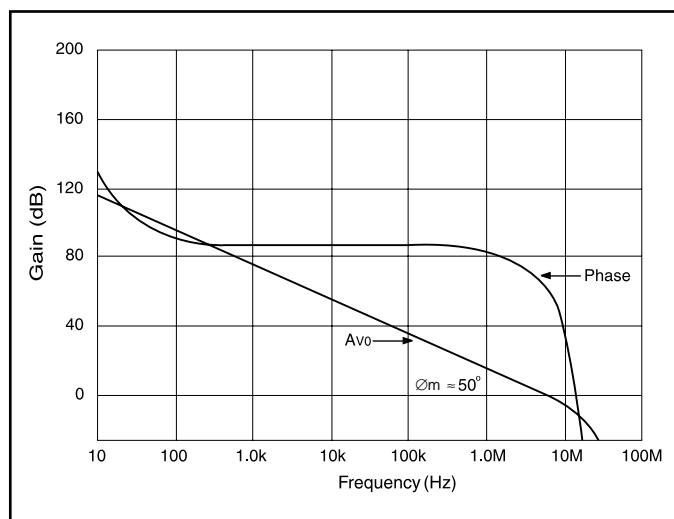
$$VSM = 0V, V_{ADJ} = 1V(\text{master}), VREF = 5V$$

$$VSP = 4 \cdot \left( \frac{R_{ADJ}}{R1 + R_{ADJ}} \right) + 1V$$

**CIRCUIT BLOCK DESCRIPTION (cont.)**

The ADJ pin voltage on the slave chips will increase forcing their load currents to increase to match the master.

The AC frequency response of the voltage error amplifier is shown in Figure 7.



**Figure 7. AC Frequency Response of the Voltage Error Amplifier**

**Startup and Shutdown:** Isolated power up can be accomplished using the UCC1889. Application Note U-149 is available for additional information.

The UC3849 offers several features that enhance startup and shutdown. Soft start is accomplished by connecting RUN to VA+ and a capacitor to ground. The resulting RC rise time on the VA+ pin initiates a soft start. It can also be accomplished by connecting RUN to ILIM. When RUN is low it will command zero load current, guaranteeing a soft start. The undervoltage lockout (UVLO) is a logical AND of  $\overline{\text{ENBL}} < 2.5\text{V}$ ,  $\text{SEQ} > 2.5\text{V}$ ,  $\text{VCC} > 8.4\text{V}$  and  $\text{VREF} > 4.65\text{V}$ . The block diagram shows that the thresholds are set by comparators. By placing an RC divider on the SEQ pin, the enabling of multiple chips can be sequenced with different RC time constants. Similarly, different RC time constants on the ENBL pins can sequence shutdown. The UVLO keeps the output from switching; however the internal reference starts up with VCC less than 8.4V. The KILL input shuts down the switching of the chip. This can be used in conjunction with an overvoltage comparator for overvoltage protection. In order to restart the chip after KILL has been initiated, the chip must be powered down and then back up. A pulse on the ENBL pin also accomplishes this without actually removing voltage to the VCC pin.

**Load Sharing:** Load sharing is accomplished similar to the UC1907. The sensed current for the UC3849 has an AC component that is amplified and then averaged. The voltage error amplifier output is the current command sig-

nal representing the average output load current. The ILIM pin programs the upper clamp voltage of this amplifier and consequently the maximum load current. A gain of 2 amplifier connected between the voltage error amplifier output and the share amplifier input increases the current share resolution and noise margin. The average current is used as an input to a source only load share buffer amplifier. The output of this amplifier is the current share bus. The IC with the highest sensed current will have the highest voltage on the current share bus and consequently act as the master. The 60mV input offset guarantees that the unit sensing the highest load current is chosen as the master.

The adjust amplifier is used by the remaining (slave) ICs to adjust their respective references high in order to balance each IC's load current. The master's ADJ pin will be at its 1.0V clamp and connected back to the non-inverting voltage error amplifier input through a high value resistor. This requires the user to initially calculate the control voltage with the ADJ pin at 1.0V.

VREF can be adjusted 150mV to 300mV which compensates for 5% unit to unit reference mismatch and external resistor mismatch.  $R_{\text{ADJ}}$  will typically be 10 to 30 times larger than R1. This also attenuates the overall variation of the ADJ clamp of  $1\text{V} \pm 100\text{mV}$  by a factor of 10 to 30, contributing only a 3mV to 10mV additional delta to VREF. Refer to the UC3907 Application Note U-130 for further information on parallel power supply load sharing.

**Current Control Loop:** The current sense amplifier (CSA) is designed specifically for the task of sensing and amplifying the inductor ripple current at frequencies up to 1MHz. The CSA's input offset voltage (VIO) is trimmed to less than 1mV to minimize error of the average current signal. This amplifier is not internally compensated allowing the user to optimally choose the zero crossing bandwidth.

$$(3) \text{ Frequency}(0\text{dB}) = \frac{1}{2\pi R_{\text{INV}} \bullet C_{\text{COMP}}}$$

$R_{\text{INV}}$  is the input resistance at the inverting terminal CS-  
 $C_{\text{COMP}}$  is the capacitance between CS- and CSO.

Although it is only unity gain stable for a GBW of 7MHz, the amplifier is typically configured with a differential gain of at least 10, allowing the amplifier to operate at 70MHz with sufficient phase margin. A closed loop gain of 10 attenuates the output by 20.8dB.

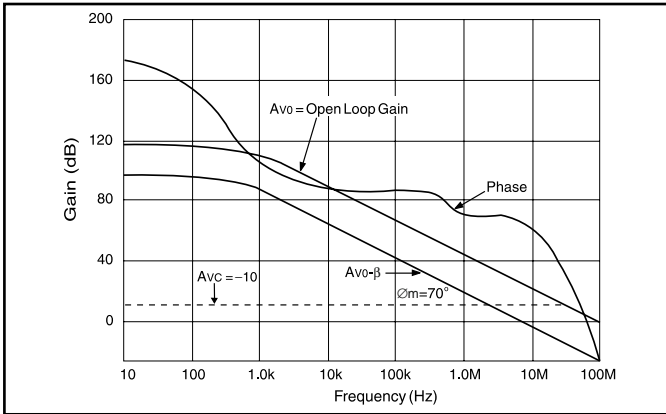
$$20.8 = 20 \log \bullet \frac{1}{11}$$

to the inverting terminal assuring stability. The amplifier's gain fed back into the inverting terminal is less than unity



## CIRCUIT BLOCK DESCRIPTION (cont.)

at 7MHz, where the phase margin begins to roll off. See Figure 8 for typical Bode plot.



**Figure 8. Current Sense Amplifier and Current Error Amplifier Bode Plot**

The gain of the differential current sense amplifier ( $CS_{GAIN}$ ) is calculated by knowing the maximum load current. The maximum voltage across the shunt resistor ( $R_S$ ) divided by  $R_S$  is the maximum load current. By amplifying the voltage across  $R_S$ ,  $V_{RS}$ , to be equal to the voltage error amplifier  $V_{oh}$ , the current control loop keeps the load from exceeding its current limit.  $V_{oh}$  is set at 3.0V if  $ILIM$  is connected to  $V_{REF}$ . The maximum current limit clamp can be reduced by reducing the voltage at  $ILIM$  to less than 3.0V as described in the  $ILIM$  pin description.

$$(4) \quad R_S = \frac{V_{RS}}{Max I_{LOAD}}$$

$$(5) \quad CS_{GAIN} = \frac{V_{ILIM}}{V_{RS}}$$

The current error amplifier (CEA) also needs its loop compensated by the user with the same criteria as the current sense amplifier. This amplifier is essentially the same wide bandwidth amplifier without the input offset voltage trim. The zero crossing can also be approximately calculated with Equation 3. The gain bandwidth of the current loop is optimized by matching the inductor downslope ( $V_O/L$ ) to the oscillator ramp slope ( $V_S \cdot f_S$ ). Subharmonic oscillation problems are avoided by keeping the amplified inductor downslope less than the oscillator ramp slope.

The following equation determines the current error amplifier gain (GCA):

$$(6) \quad GCA = \frac{V_S \cdot f_S}{(V_O / L) \cdot R_S \cdot CS_{GAIN}};$$

where  $CS_{GAIN}$  and  $R_S$  are defined by equations

4 and 5,

$V_S$  is the oscillator peak to peak voltage,

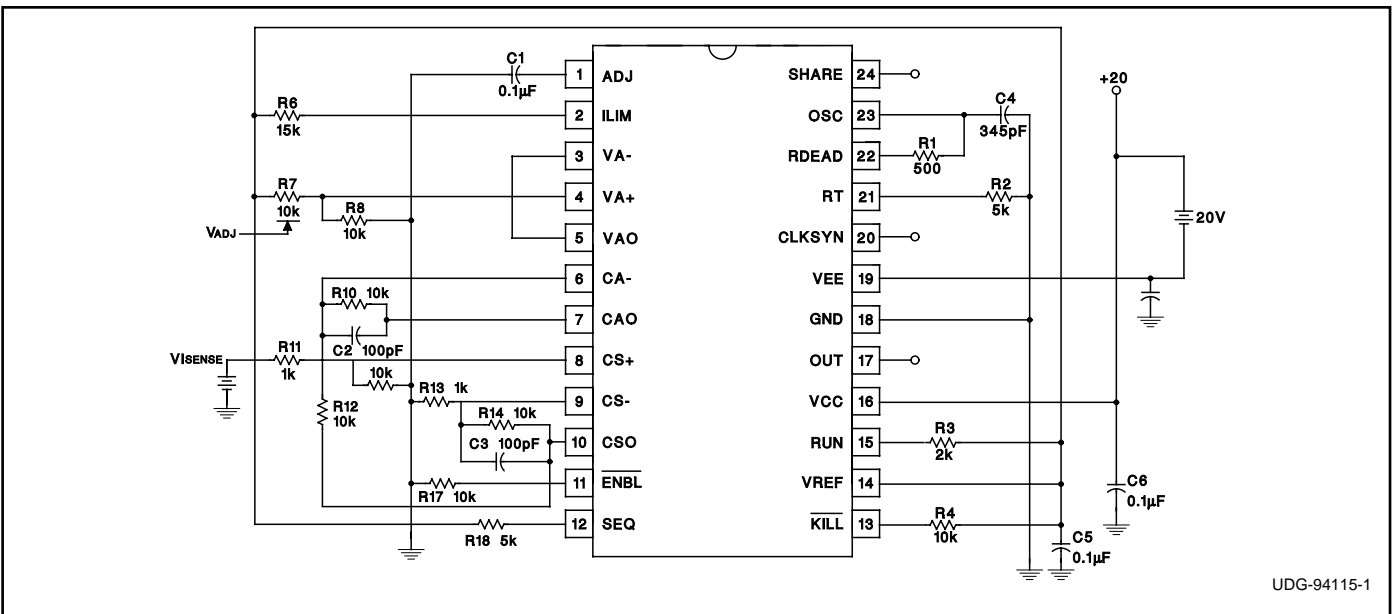
$f_S$  is the oscillator frequency,

$V_O$  is the output voltage,

and  $L$  is the inductance.

Additional Information about average current mode control can be found in Unitrode Application Note U-140.

**Design Example:** Figure 9 is an open loop test that lets the user test the circuit blocks discussed without having to build an entire control loop. The pulse width can be varied by either the  $V_{ADJ}$  or the  $V_{ISENSE}$  inputs. Figure 10 shows an isolated power supply using the UC3849 secondary side average current mode controller.



**Figure 9. Open Loop Circuit**

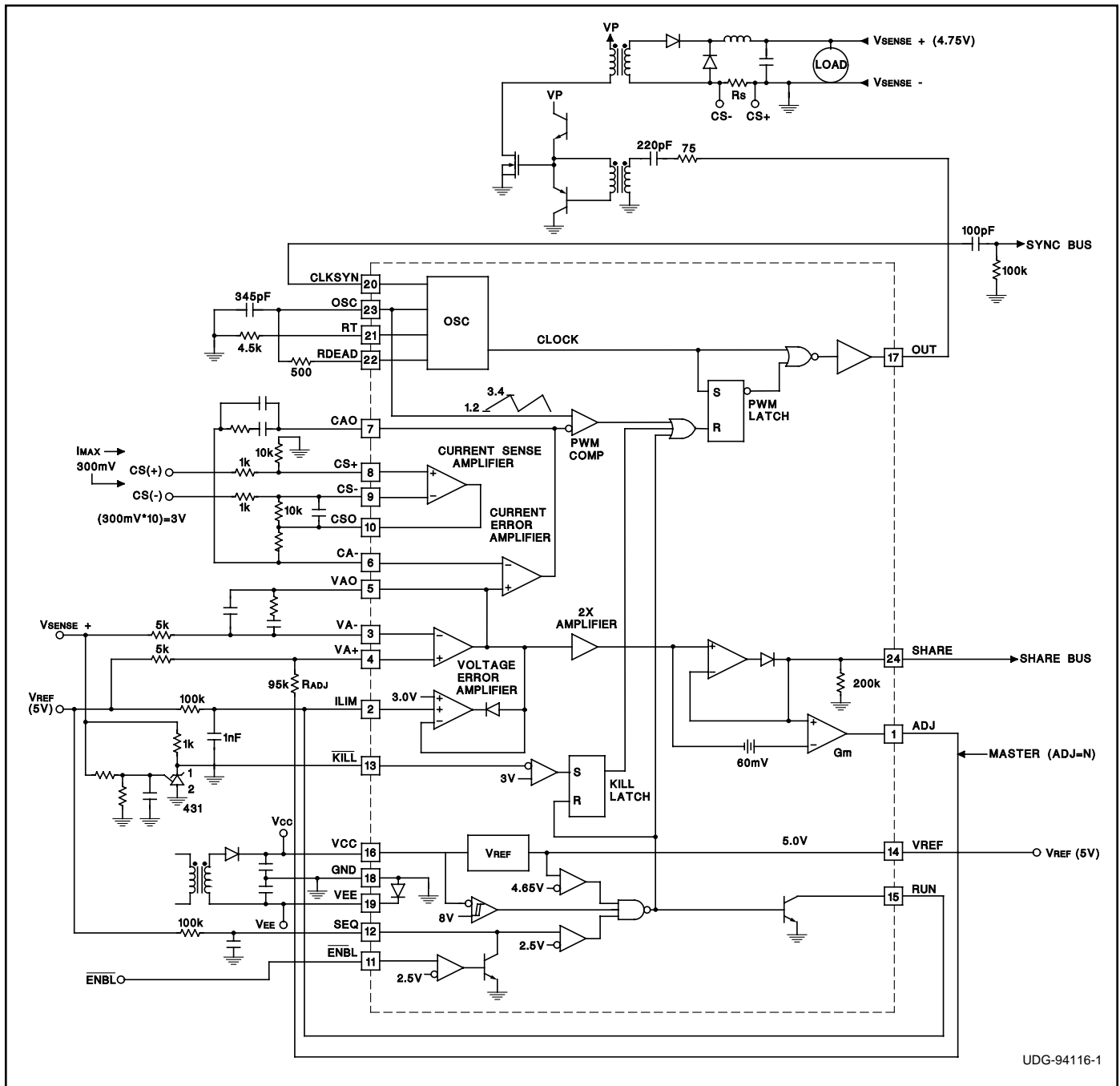


Figure 10. UC3849 Application Diagram

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